

# **USB480B - PRELIMINARY**

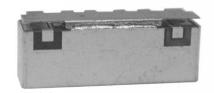
# 4700-4900MHz USB Series TDD Bandpass Filter

#### **Features**

- Low Loss with High Rejection and Low Ripple
- Support for 3GPP Receive Blocker specification
- Universal footprint across family for all TDD bands

### **Applications**

- Wireless Infrastructure applications
- High-performance carrier-grade single-band TDD Pico-cell basestations for up to 5.0W at the antenna port.



Part Dimensions:  $25.7 \times 4.8 \times 6.6$  mm • 2.5 g Materials: Ag plated ceramic block with tin plated brass shield

#### Description

Surface mount ceramic bandpass filter supports a universal footprint across all TDD frequency bands enabling the use of a common system PCB. Superior rejection, insertion loss, reliability, as well as both peak and average power handling compared to other bandpass filter technologies.

# **Electrical Specifications**

Parameter	Frequency (MHz)	Typical at 25°C	Spec. at 25°C	Spec. over -40°C to +85°C
Nominal Impedance	-	50 ohms	_	_
Average Input Power	-	-	-	8.0 Watt max
Peak Input Power	-	-	-	80 Watt max
Input-Output Response				
Passband Insertion Loss (5 MHz avg)	4700-4900	1.7 dB	1.9 dB max	2.0 dB max
Passband Ripple (20MHz)	4700-4900	1.2 dB	1.4 dB max	1.5 dB max
Passband Return Loss	4700-4900	14 dB	12 dB min	12 dB min
Attenuation:	1-2690	43 dB	40 dB min	40 dB min
	2691-4200	38 dB	35 dB min	35 dB min
	4201-4680	8 dB	6 dB min	6 dB min
	4920-5149	8 dB	6 dB min	6 dB min
	5150-5549	33 dB	30 dB min	30 dB min
	5550-TBD	43 dB	38 dB min	38 dB min

Note: CTS tests each unit to the critical specifications above. Subsequent audits may deviate due to repeatability among different test systems which shall not exceed these allowances.

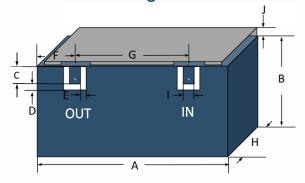
<u>lowance</u>
0.1 dB
1.0 dB
1.0 dB

2023-05-12 Rev. A Page 1 of 2





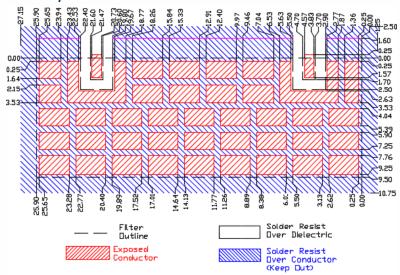
## **Mechanical Drawing**



### **PCB Layout**

44.0 mm

5.30 mm



Dim.	Nominal (mm)	Tolerance (±mm or Max)	
Α	25.40	0.30	
В	3.40	0.30	
С	1.70	0.13	
D	0.80	0.13	
Е	0.80	0.13	
F	4.20	0.13	
G	16.90	0.13	
Н	6.40	0.20	
- 1	1.00	0.13	
J	0.90	0.20	

IMPORTANT: Please assure >=20mils (0.5mm) thickness of dielectric beneath the I/O Pads and surrounding clearance zone to the required ground plane.

NOTE: The width of 9.50mm is necessary to support frequencies as low as 1885MHz for Band 39. If only higher frequency TDD bands are supported, then a smaller space can be allocated on the layout.

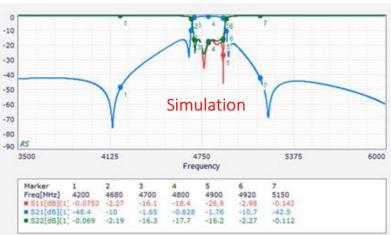
## Packaging and Marking

Dimensi	on Unit	s Spec.	- Prod <u>uct</u>	Marking			
Reel Diam		330 5.5		CTS BOB			
Reel Quan		500	- Y\	VW			
Customer Feed Direction $\rightarrow$ $\rightarrow$ $\rightarrow$							
Po	•		Wo MM/(Inches)	Bo MM/(Incl			
MM/(Inches)	200	Ao MM/(Inch	es)	MM/(Inches)			
$W_{o}$	$A_{o}$	Bo	Ko	Po			
1.732 in	0.209 in	1.028 in	0.283 in	0.472 in			

26.10 mm

7.20 mm

# **Electrical Response**



12.0 mm